

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : 7,345,350 B2
APPLICATION NO. : 10/668914
DATED : March 18, 2008
INVENTOR(S) : Sinha

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

In column 13, lines 6-7, in Claim 3, delete "polysilicon, solder paste and a solder alloy."
and insert -- polysilicon and solder paste. --, therefor.

Signed and Sealed this

Twenty-first Day of October, 2008

A handwritten signature in black ink, appearing to read "Jon W. Dudas". The signature is stylized with a large, looped initial "J" and a distinct "D" at the end.

JON W. DUDAS
Director of the United States Patent and Trademark Office